

### **MOSFET**

### OptiMOS<sup>™</sup> 3 Power-Transistor, 75 V

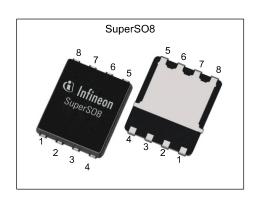
#### **Features**

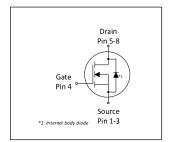
- Optimized technology for synchronous rectification
- Ideal for high frequency switching and DC/DC converters
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Superior thermal resistance

- N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



Table 1 110 y 1 01101111anico 1 araniciore							
Parameter	Value	Unit					
V <sub>DS</sub>	75	V					
R <sub>DS(on),max</sub>	4.2	mΩ					
I <sub>D</sub>	132	Α					











Type / Ordering Code	Package	Marking	Related Links
BSC042NE7NS3 G	PG-TDSON-8	042NE7NS	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Danamatan	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	ID	- - -	-	132 83 19	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50 K/W <sup>2)</sup>	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	528	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	220	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	$P_{tot}$	-	-	125 2.5	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 K/W <sup>2)</sup>	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	$R_{thJC}$	_	-	1.0	K/W	-	
Thermal resistance, junction - case, top	$R_{thJC}$	-	-	18	K/W	-	
Device on PCB, minimal footprint	$R_{thJA}$	-	-	62	K/W	-	
Device on PCB, 6 cm² cooling area²)	$R_{thJA}$	-	-	50	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air. <sup>3)</sup> See Diagram 3 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

D	0		Values				
Parameter	Symbol	Min.	n. Typ. Max.		Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	75	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.3	3.1	3.8	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=91\ \mu {\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μA	V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =75 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	$I_{\mathrm{GSS}}$	_	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	_	3.7	4.2	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A	
Gate resistance	R <sub>G</sub>	_	2.2	-	Ω	-	
Transconductance	$g_{fs}$	44	89	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =50 A	

Table 5 **Dynamic characteristics** 

Danamatan	0	Values			11	Note / Total Constitution
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	3600	4800	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	810	1100	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C <sub>rss</sub>	-	40	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =37.5 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	14	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$
Rise time	t <sub>r</sub>	-	17	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	34	-	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$
Fall time	t <sub>f</sub>	-	9	_	ns	$V_{\rm DD}$ =37.5 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.8 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Parameter	Cumbal	Values			Unit	Note / Test Condition	
raiametei	Symbol Min.	Min.	Тур.	Max.	Ullit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	18.3	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate to drain charge	$Q_{\mathrm{gd}}$	-	10.4	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	17.6	-	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	$Q_g$	-	52	69	nC	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.1	-	V	$V_{DD}$ =37.5 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	53	71	nC	V <sub>DD</sub> =37.5 V, V <sub>GS</sub> =0 V	

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

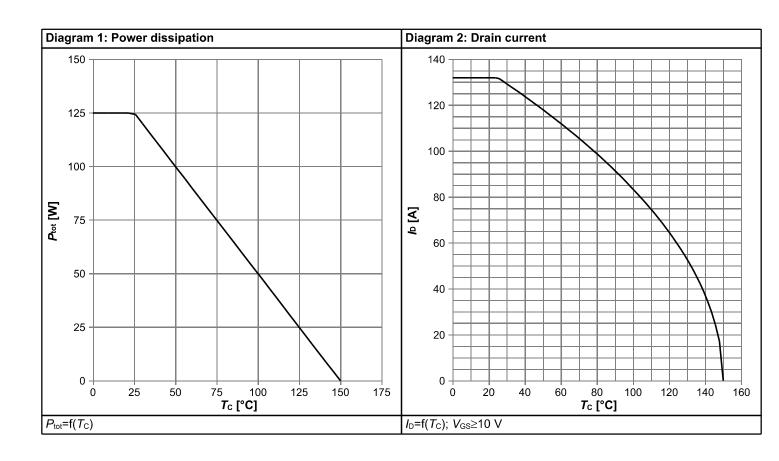


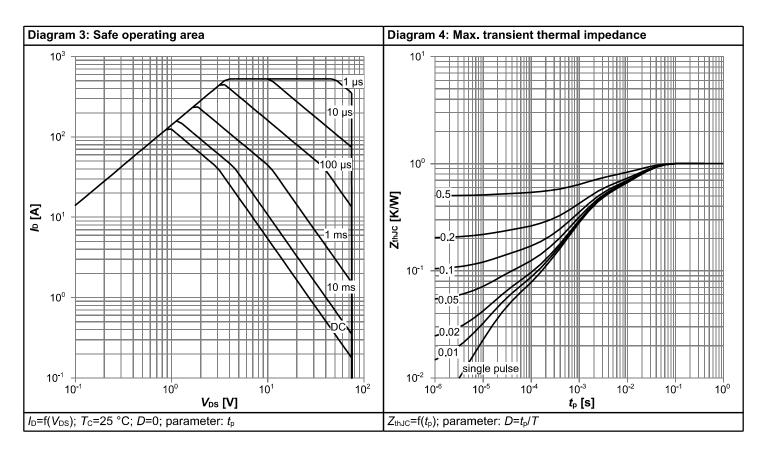
### Table 7 Reverse diode

Davamatar	Symbol	Values			11:4	Note (Total Constitution	
Parameter	Symbol	Symbol Min. Typ.	Max.	Unit	Note / Test Condition		
Diode continuous forward current	Is	-	-	90	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	528	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.89	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	44	-	ns	V <sub>R</sub> =40 V, I <sub>F</sub> =25A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge	Q <sub>rr</sub>	-	64	-	nC	$V_R$ =40 V, $I_F$ =25A, $di_F/dt$ =100 A/ $\mu$ s	

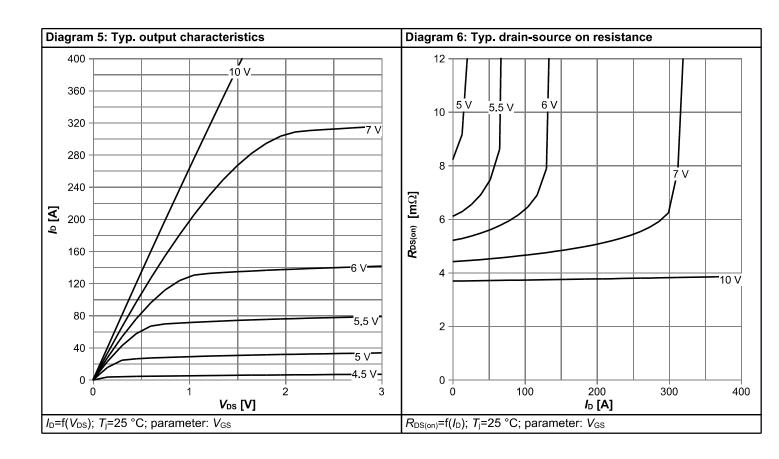


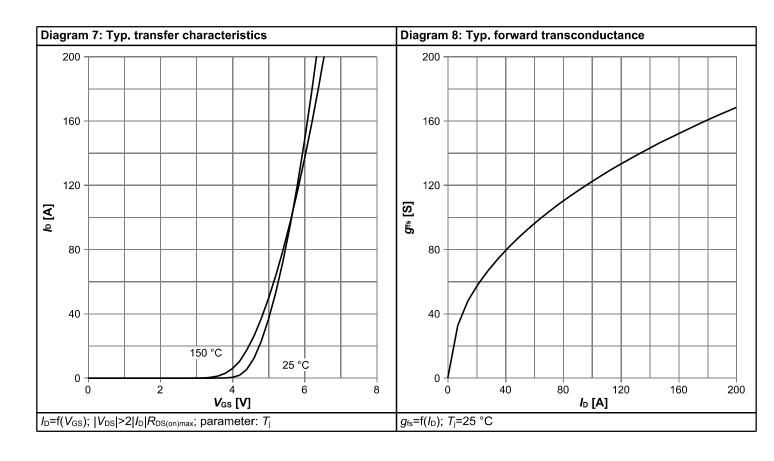
## 4 Electrical characteristics diagrams



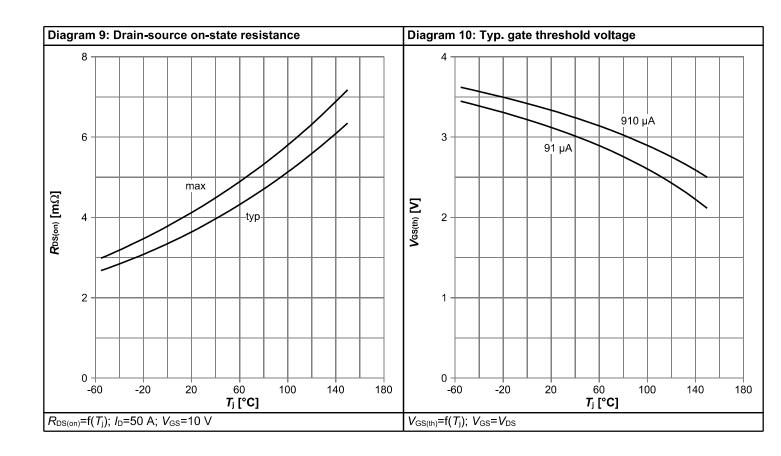


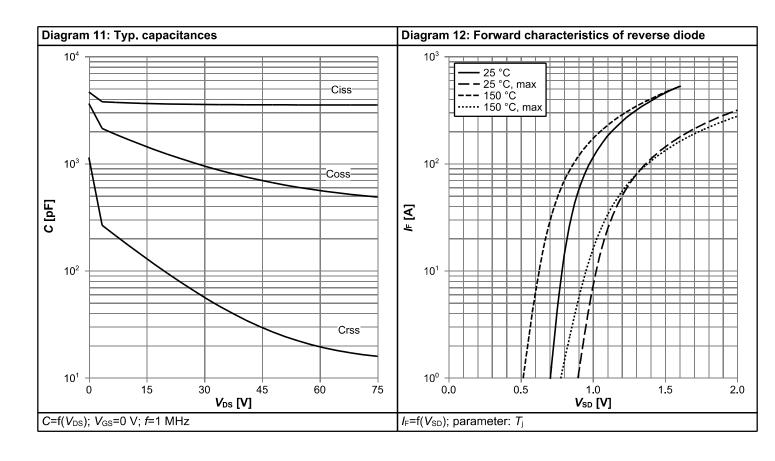




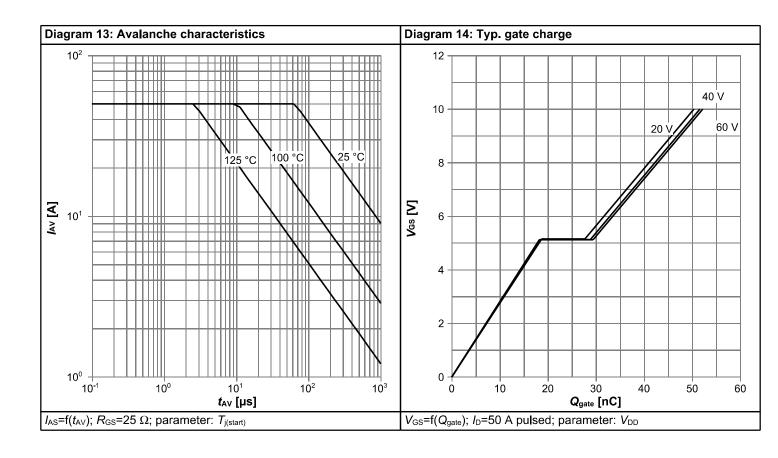


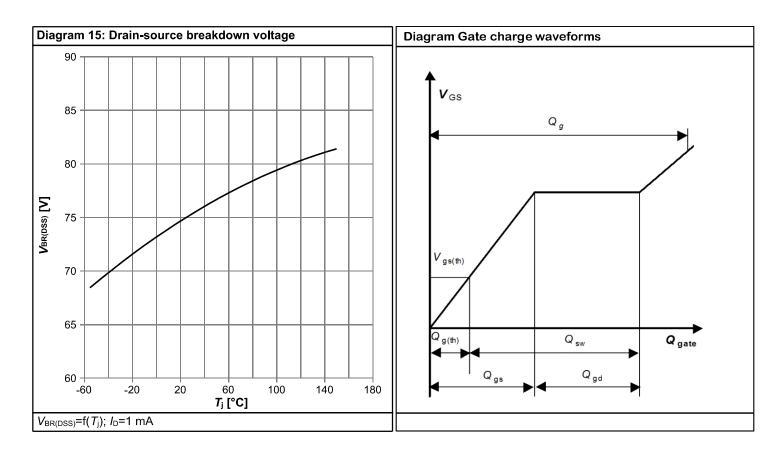






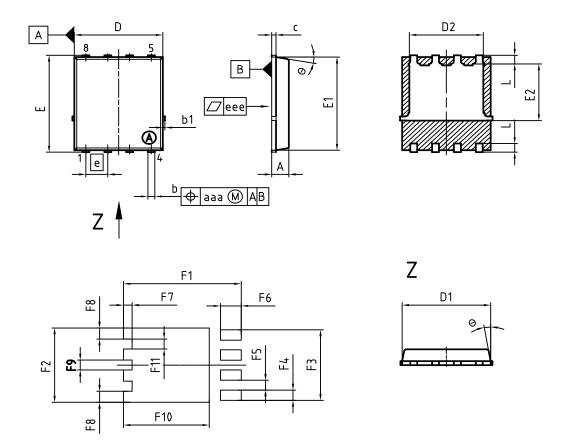








## 5 Package Outlines



DIM	MILLIN	IETERS	INC	HES			
DIM	MIN	MAX	MIN	MAX			
Α	0.90	1.10	0.035	0.043			
b	0.34	0.54	0.013	0.021			
b1	0.02	0.22	0.001	0.008			
С	0.15	0.35	0.006	0.014			
D=D1	4.95	5.35	0.195	0.211			
D2	4.20	4.40	0.165	0.173			
E	5.95	6.35	0.234	0.250			
E1	5.70	6.10	0.224	0.240			
E2	3.40	3.80	0.134	0.150			
е	1.2	27	0.050				
N	8		8				
L	0.45	0.65	0.018	0.026			
Θ	8.5°	11.5°	8.5°	11.5°			
aaa	0.2	25	0.010				
eee	0.0	05	0.	002			
F1	6.75	6.95	0.266	0.274			
F2	4.60	4.80	0.181	0.189			
F3	4.36	4.56	0.172	0.180			
F4	0.55	0.75	0.022	0.030			
F5	0.52	0.72	0.020	0.028			
F6	1.10	1.30	0.043	0.051			
F7	0.40	0.60	0.016	0.024			
F8	0.60	0.80	0.024	0.031			
F9	0.53	0.73	0.021	0.029			
F10	4.90	5.10	0.193	0.201			
F11	0.53	0.73	0.021	0.029			

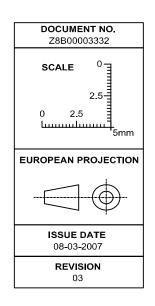


Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



#### **Revision History**

BSC042NE7NS3 G

Revision: 2021-05-10, Rev. 2.3

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.3	2021-05-10	Update current rating and footnotes

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